

Product data sheet

1. General description

Ultrafast power diode in a SMC package.

2. Features and benefits

- · Fast switching
- SMC package
- High voltage capability
- Low forward voltage drop
- Low leakage current
- Low thermal resistance
- Soft recovery characteristic

3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- High frequency switched-mode power supplies

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values				Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		600			V	
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _{lead} ≤ 96 °C; Fig. 1; Fig. 2; Fig. 3	5			A	
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{lead} ≤ 96 °C; square-wave pulse	10			A	
I _{FSM}	non-repetitive peak forward current	$t_{\rm p}$ = 10 ms; $T_{\rm j(init)}$ = 25 °C; sine-wave pulse; Fig. 4				A	
		t_{p} = 8.3 ms; $T_{\text{j(init)}}$ = 25 °C; sine-wave pulse			А		
Symbol	Parameter	Conditions	Notes Min Typ Max		Unit		
Static ch	aracteristics						
V _F	forward voltage	I _F = 5 A; T _j = 25 °C		-	1.10	1.35	V
		I _F = 5 A; T _j = 150 °C		-	0.9	1.15	V
Dynamic	characteristics						
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt= 50 A/us; T _j = 25 °C; <u>Fig. 7</u>		-	45	-	ns
						1	1

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	A	anode		K — — — A 001aaa020

6. Ordering information

Table 3. Ordering information						
Type number		Orderable part number		Small packing	Package	Package
	Name		method	quantity	version	issue date
MUR560	SMC	MUR560J	Reel	3000	SMCS	16-Aug-2017
		MUR560,118				

7. Marking

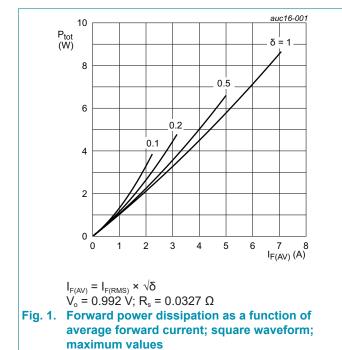
Table 4. Marking codes							
Type number	Marking codes						
	Assembly factory: S	Assembly factory: E					
MUR560	560JS	560JE					

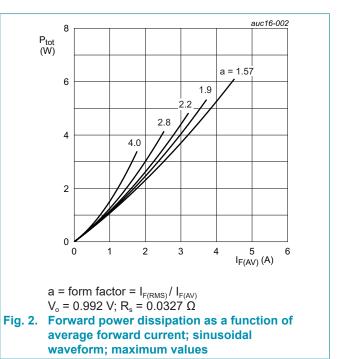
8. Limiting values

Table 5. Limiting values

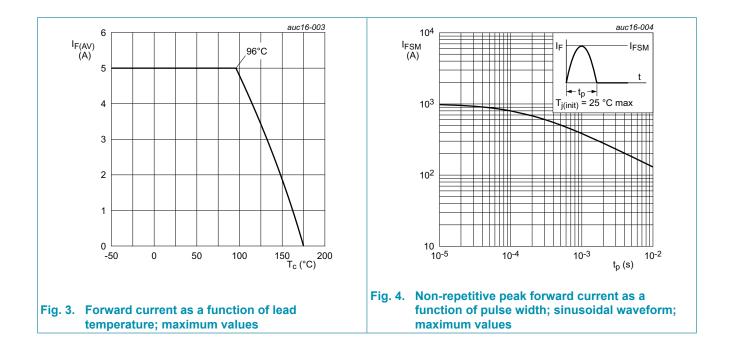
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{lead} ≤ 96 °C; Fig. 1; Fig. 2; Fig. 3	5	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{lead} ≤ 96 °C; square-wave pulse	10	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	130	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	143	А
T _{stg}	storage temperature		-65 to 175	°C
Tj	junction temperature		175	°C



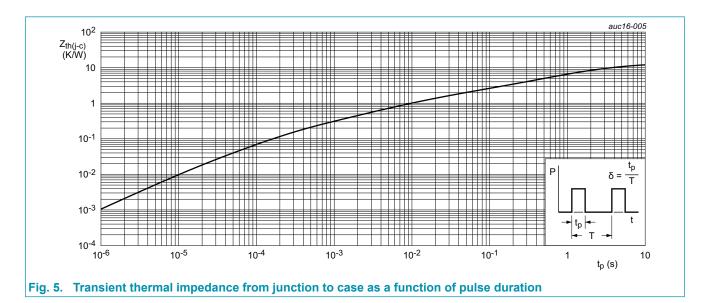


MUR560 Ultrafast power diode



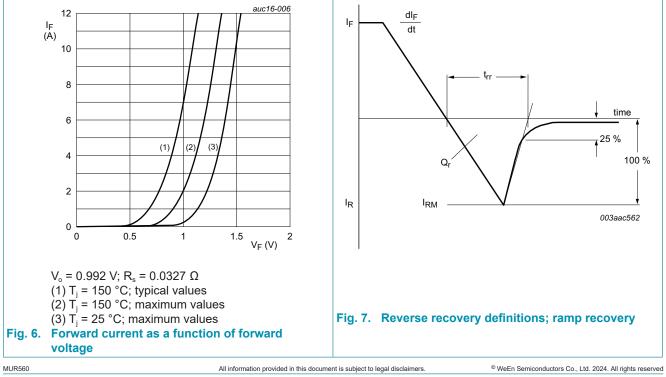
9. Thermal characteristics

Table 6. Th	ermal characteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	mounted on a minimum footprint printed-circuit board (FR4); <u>Fig. 5</u>		-	-	12	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	mounted on a minimum footprint printed-circuit board (FR4)		-	75	-	K/W

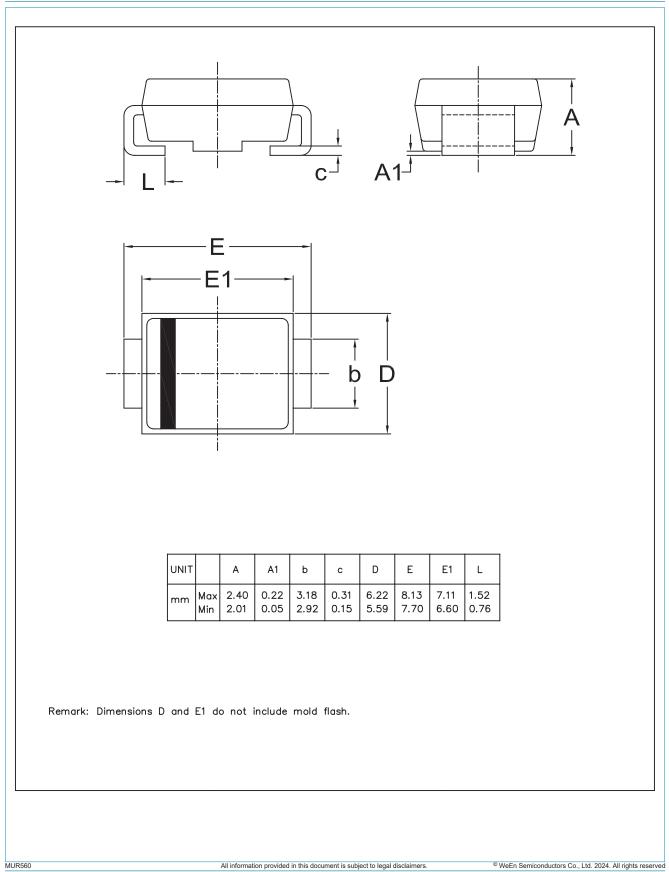


10. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V_{F}	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.10	1.35	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 6</u>		-	0.9	1.15	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C		-	-	3	μA
		V _R = 600 V; T _j = 150 °C		-	-	250	μA
Dynamic	characteristics						
Q _r	reverse charge	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A/us};$ $T_j = 25 \text{ °C}; Fig. 7$		-	216	-	nC
		$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A/us};$ $T_j = 125 \text{ °C}; Fig. 7$		-	420	-	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}_F/\text{d}t= 50 \text{ A/us};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	45	-	ns
		$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ Step recovery}$		-	-	65	ns
		$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A/us};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	64	-	ns
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/us; T _j = 125 °C; <u>Fig. 7</u>		-	88	-	ns
I _{RM}	peak reverse recovery current	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A/us};$ $T_j = 25 ^\circ\text{C}; \text{ Fig. 7}$		-	6.7	-	A
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/us; T _j = 125 °C; <u>Fig. 7</u>		-	9.5	-	A
E _{as}	non-repetitive avalanche energy	I _R = 1.2 A; T _{j(init)} = 25 °C; L = 15 mH		10.8	-	-	mJ



11. Package outline



12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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13. Contents

1. General description	1
2. Features and benefits	1
3. Applications	1
4. Quick reference data	1
5. Pinning information	2
6. Ordering information	2
7. Marking	2
8. Limiting values	3
9. Thermal characteristics	5
10. Characteristics	6
11. Package outline	7
12. Legal information	8
13. Contents	10

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